

• General Description

The AGM30N10D combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{\text{DS(ON)}}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

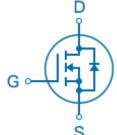
Product Summary

BVDSS	RDSON	ID
100V	26mΩ	28A

TO-252 Pin Configuration







Top View

Bottom View

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM30N10D	AGM30N10D	TO-252	330mm	16mm	2500

Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	100	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	28	А
	Drain Current-Continuous(T⊂=100 °C)	19	А
IDM (pluse)	Drain Current-Pulsed (Note 2)	112	А
PD	Maximum Power Dissipation(Tc=25℃)	50	W
	Maximum Power Dissipation(Tc=100℃)	20	w
EAS	Avalanche energy (Note 3)	22	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹		50	°C/W
RθJC	Thermal Resistance Junction-Case ¹		2.5	°C/W



Table 3. Electrical Characteristics (TJ=25 ℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250µA	100			V
IDSS	Zero Gate Voltage Drain Current	VDS=100V,VGS=0V			1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	1.2	1.8	2.2	V
gFS	Forward Transconductance	VDS=5V,ID=8A		13		S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=10A		26	31	mΩ
(/		VGS=4.5V, ID=8A		33	38	mΩ
Dynamic (Characteristics					
Ciss	Input Capacitance			445		pF
Coss	Output Capacitance	VDS=40V,VGS=0V,		171		pF
Crss	Reverse Transfer Capacitance	F=1MHZ		3.2		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		4.5		Ω
Switching	Times					
td(on)	Turn-on Delay Time			12		nS
tr	Turn-on Rise Time	VGS=10V,VDS=50V,		15		nS
td(off)	Turn-Off Delay Time	ID=10A,RGEN=5Ω		20		nS
tf	Turn-Off Fall Time			6.0		nS
Qg	Total Gate Charge			8.0		nC
Qgs	Gate-Source Charge	VGS=10V, VDS=50V, ID=10A		1.4		nC
Qgd	Gate-Drain Charge			1.8		nC
Source-Dr	ain Diode Characteristics					
ISD	Source-Drain Current(Body Diode)				28	А
VSD	Forward on Voltage	VGS=0V,IS=10A			1.2	V
trr	Reverse Recovery Time	IF=10A , dI/dt=100A/μs ,		37		ns
Qrr	Reverse Recovery Charge	TJ=25℃		80		nc

Notes 1. The maximum current rating is package limited.

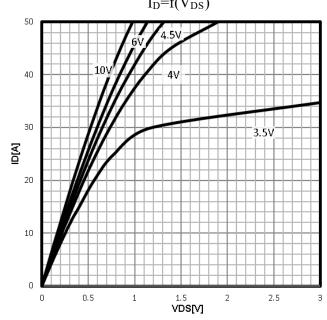
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25 $^{\circ}$,VDD=50V,Vgs=10V,ID=21A, L=0.1mH,RG=25ohm

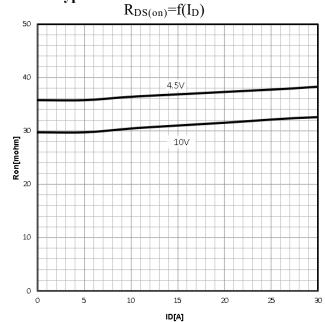


Characteristics Curve:

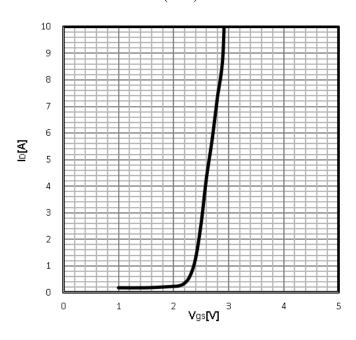
Typ. output characteristics $I_D\!\!=\!\!f(V_{DS})$



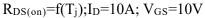
Typ. drain-source on resistance $R_{\mathrm{DS(on)}}\!\!=\!\!f(I_D)$

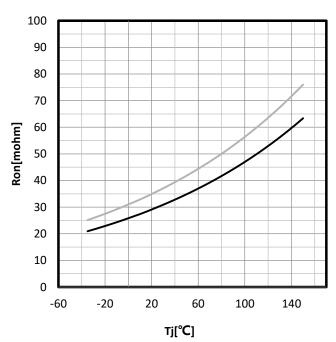


Typ. transfer characteristics $I_D = f(V_{GS})$



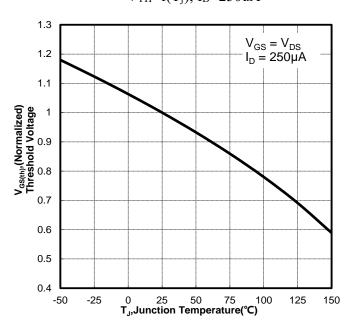
Drain-source on-state resistance



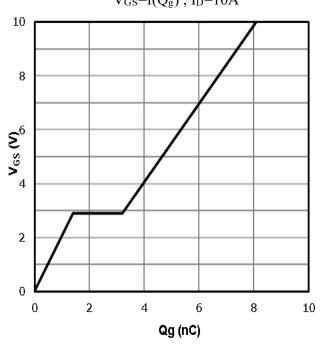




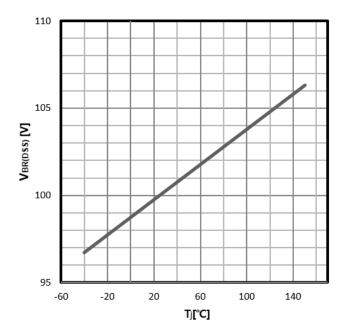
 $\begin{aligned} \textbf{Gate Threshold Voltage} \\ V_{TH} = & f(T_j); \ I_D = 250 uA \end{aligned}$



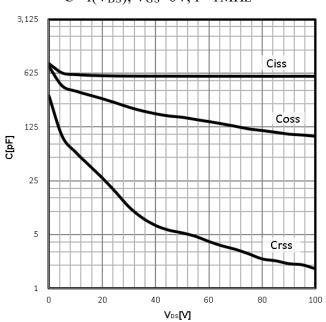
 $\begin{aligned} & \textbf{Typ. gate charge} \\ & V_{GS} \text{=} f(Q_g) \; ; \; I_D \text{=} 10 A \end{aligned}$



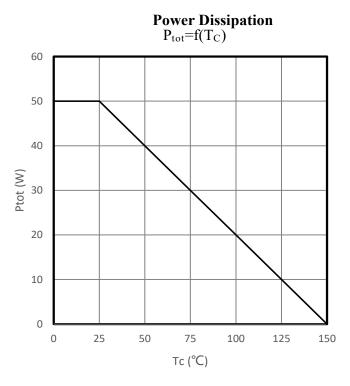
 $\begin{array}{c} \textbf{Drain-source breakdown voltage} \\ V_{BR(DSS)} = f(T_j); \ I_D = 250 uA \end{array}$

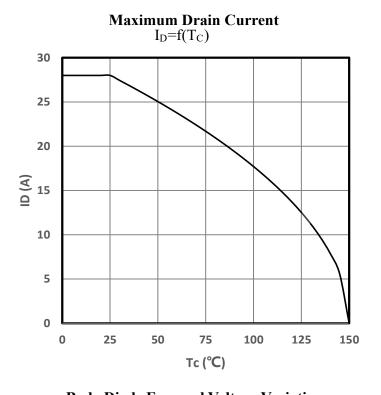


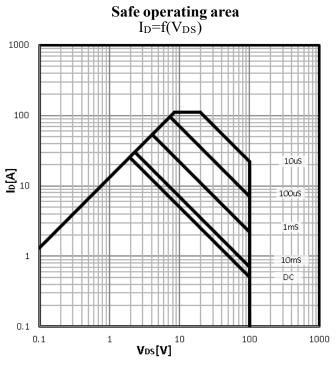
$$\label{eq:capacitances} \begin{split} & \textbf{Typ. capacitances} \\ & C = & f(V_{DS}); \, V_{GS} = & 0V; \, f = & 1MHz \end{split}$$

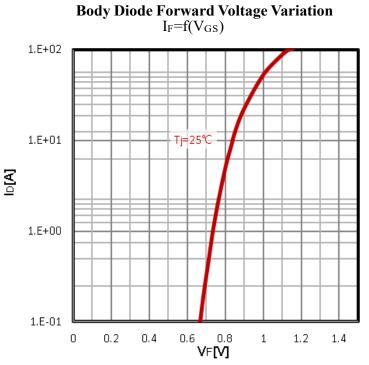






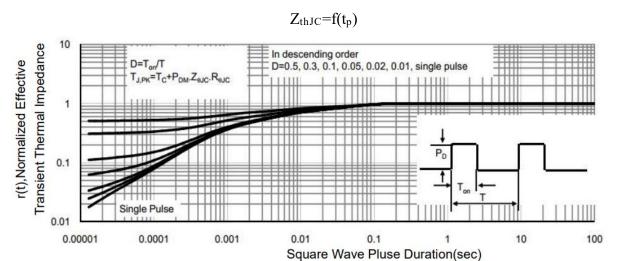






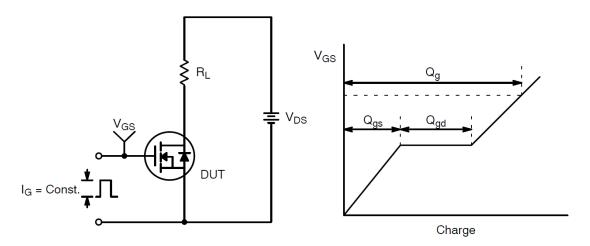


Max. transient thermal impedance

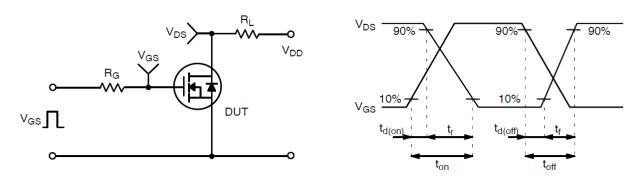




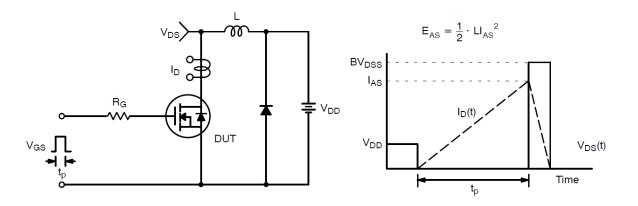
Test Circuit and Waveform:



Gate Charge Test Circuit & Waveform



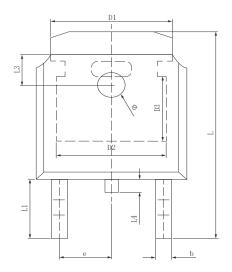
Resistive Switching Test Circuit & Waveforms

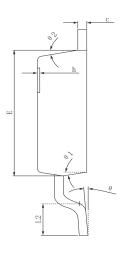


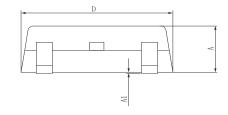
Unclamped Inductive Switching Test Circuit & Waveforms



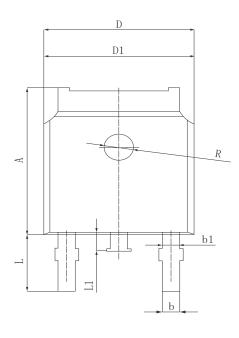
•Dimensions (TO-252)

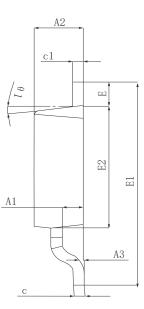


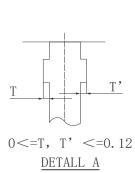




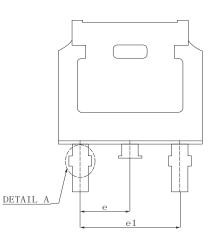
CYMPOL	MILLIMETER			
SYMBOL	MIN	Typ.	MAX	
A	2. 200	2. 300	2.400	
A1	0.000		0.127	
b	0.640	0.690	0.740	
c(电镀后)	0.460	0.520	0.580	
D	6.500	6.600	6. 700	
D1		5.334 REF		
D2		4.826 REF		
D3		3.166 REF		
Е	6.000	6. 100	6. 200	
е		2.286 TYP		
h	0.000	0.100	0.200	
L	9.900	10.100	10.300	
L1	2.888 REF			
L2	1.400	1.550	1.700	
L3	1.600 REF			
L4	0.600	0.800	1.000	
Φ	1.100	1. 200	1.300	
θ	0°		8°	
θ 1	9° TYP			
θ2	9° TYP			





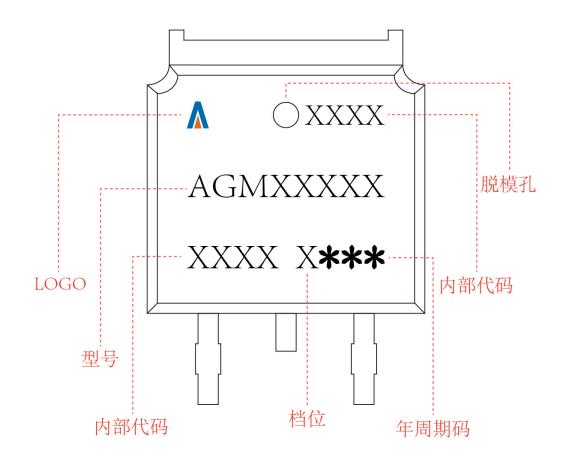


CIRPOI	MILLIMETER			
SYMBOL	MIN	NOM	MAX	
A	7.050	7. 100	7. 150	
A1	0.960	1.010	1.060	
A2	2. 250	2. 300	2. 350	
А3	0.000	0.050	0.100	
b		0.760REF.		
b1		1.000REF.		
С		0.508REF.		
c1		0.508REF.		
D	6. 550	6.600	6.650	
D1	5. 220	5. 320	5. 420	
Е	0.950	1.000	1.050	
E1	9.700	9. 900	10.100	
E2	6.050	6. 100	6.150	
е		2.286BSC		
e1	4. 572REF.			
L	2.650	2.800	2.950	
L1	0.700	0.800	0.900	
θ 1	7° REF.			
R	1. 300REF.			
R1	0. 250REF.			





TO-252 Marking Instructions:





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